

**RoHS** 

COMPLIANT HALOGEN

FREE

Available

# N- and P- Channel 20 V (D-S) MOSFET

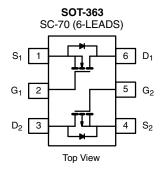
PRODUCT SUMMARY						
	V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω)	I <sub>D</sub> (A)			
N-Channel		0.090 at V <sub>GS</sub> = 4.5 V	3.28			
	20	0.110 at V <sub>GS</sub> = 2.5 V	2.13			
		0.130 at V <sub>GS</sub> = 1.8 V	1.50			
		0.155 at V <sub>GS</sub> = - 4.5 V	- 2.80			
P-Channel	- 20	0.190 at V <sub>GS</sub> = - 2.5 V	- 1.81			
		0.220 at V <sub>GS</sub> = - 1.8 V	- 1.15			

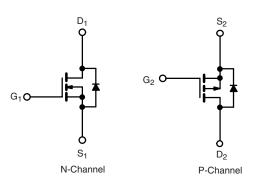
#### FEATURES

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFETs: 1.8 V Rated
- Thermally Enhanced SC-70 Package
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

Load Switch for Portable Devices





<b>ABSOLUTE MAXIMUM RATINGS</b> $T_A = 25 \text{ °C}$ , unless otherwise noted								
			N-Channel		P-Channel			
Parameter		Symbol	5 s	Steady State	5 s	Steady State	Unit	
Drain-Source Voltage		V <sub>DS</sub>	20		- 20		V	
ate-Source Voltage		V <sub>GS</sub>	± 20		± 20		v	
Continuous Drain Current $(T_J = 150 \ ^{\circ}C)^a$	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	3.28	3.03	- 2.80	- 2.58		
	T <sub>A</sub> = 85 °C		2.12	1.81	- 1.72	- 1.53	А	
Pulsed Drain Current		I <sub>DM</sub>	9.5		- 8.5		A	
Continuous Source Current (Diode Conduction) <sup>a</sup>		۱ <sub>S</sub>	2.61	2.48	- 1.61	-1.48		
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C	Р	1.24	1.17	1.10	0.97	w	
	T <sub>A</sub> = 85 °C	P <sub>D</sub>	0.88	0.75	0.66	0.5		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150				°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient <sup>a</sup>	t ≤ 5 s	- R <sub>thJA</sub>	130	170			
Maximum Junction-to-Ambient	Steady State		170	220	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	80	100			

Notes:

a. Surface mounted on 1" x 1" FR4 board.

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<b>SPECIFICATIONS</b> $T_J = 25 \text{ °C}$ , unless otherwise noted									
Parameter	Symbol	Test Conditions		Min.	Тур.	Max.	Unit		
Static							-		
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 100 \ \mu A$	N-Ch	0.45		1	V		
		$V_{DS} = V_{GS}, I_{D} = -100 \ \mu A$	P-Ch	- 0.45		1			
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = \pm 8 \text{ V}$	N-Ch			± 100	nA		
Gale-Dody Leakage			P-Ch			± 100			
	1	$V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch			1			
Zero Gate Voltage Drain Current		$V_{DS} = -16 V, V_{GS} = 0 V$				- 1	ıιΔ		
Zelo dale vollage Dialit Gurrent	I <sub>DSS</sub>	$V_{DS}$ = 16 V, $V_{GS}$ = 0 V, $T_{J}$ = 85 $^{\circ}\text{C}$	N-Ch			5	μΑ		
		$V_{DS}$ = - 16 V, $V_{GS}$ = 0 V, $T_{J}$ = 85 °C	P-Ch			- 5			
On-State Drain Current <sup>a</sup>		$V_{DS} \ge 5$ V, $V_{GS} = 4.5$ V	N-Ch	2			А		
	I <sub>D(on)</sub>	$V_{DS}{\leq}$ - 5 V, $V_{GS}{=}$ - 4.5 V	P-Ch	- 2					
		$V_{GS}$ = 4.5 V, I <sub>D</sub> = 2.55 A	N-Ch		0.090				
		$V_{GS}$ = - 4.5 V, I <sub>D</sub> = - 1.85 A	P-Ch		0.155		Ω		
Drain-Source On-State Resistance <sup>a</sup>	Brach	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 1.55 \text{ A}$	N-Ch		0.110				
	R <sub>DS(on)</sub>	$V_{GS}$ = - 2.5 V, I <sub>D</sub> = - 1.35 A	P-Ch		0.190		52		
		$V_{GS} = 1.8$ V, $I_D = 0.50$ A	N-Ch		0.130				
		$V_{GS}$ = - 1.8 V, I <sub>D</sub> = - 0.50 A	P-Ch		0.220				
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1.13 A	N-Ch		2.6		s		
rolward hanscondiciance		V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 0.88 A	P-Ch		1.5				
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	I <sub>S</sub> = 0.48 A, V <sub>GS</sub> = 0 V	N-Ch		0.8	1.2	v		
-		$I_{S} = -0.48 \text{ A}, V_{GS} = 0 \text{ V}$	P-Ch		- 0.8	- 1.2	v		
Dynamic <sup>b</sup>	•		•			1			
Total Gate Charge	Qg	N-Channel	N-Ch		1.25	2	nC		
	∽g	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 2.55 \text{ A}$	P-Ch		1.2	1.8			
Gate-Source Charge	Q <sub>gs</sub>		N-Ch		0.21				
		P-Channel V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 0.88	P-Ch		0.3				
Gate-Drain Charge	Q <sub>gd</sub>	A	N-Ch		0.3				
			P-Ch		0.21				
Turn-On Delay Time	t <sub>d(on)</sub>		N-Ch		15	25			
		N-Channel	P-Ch		18	30	ns		
Rise Time		$V_{DD} = 10 \text{ V}, \text{ R}_{L} = 20 \Omega$	N-Ch		22	35			
		$\text{I}_{\text{D}}\cong$ 0.5 A, $\text{V}_{\text{GEN}}$ = 4.5 V, $\text{R}_{\text{g}}$ = 6 $\Omega$	P-Ch		25	40			
Turn-Off Delay Time	t <sub>d(off)</sub>	P-Channel	N-Ch		25	40			
		$V_{DD} = -10 V, R_L = 20 \Omega$	P-Ch		15	25			
Fall Time	t <sub>f</sub>	$I_D \cong$ - 0.5 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 6 $\Omega$	N-Ch		12	20			
			P-Ch		12	20			
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 0.48 A, dl/dt = 100 A/μs	N-Ch		30	60			
	۲r		P-Ch		30	60			

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

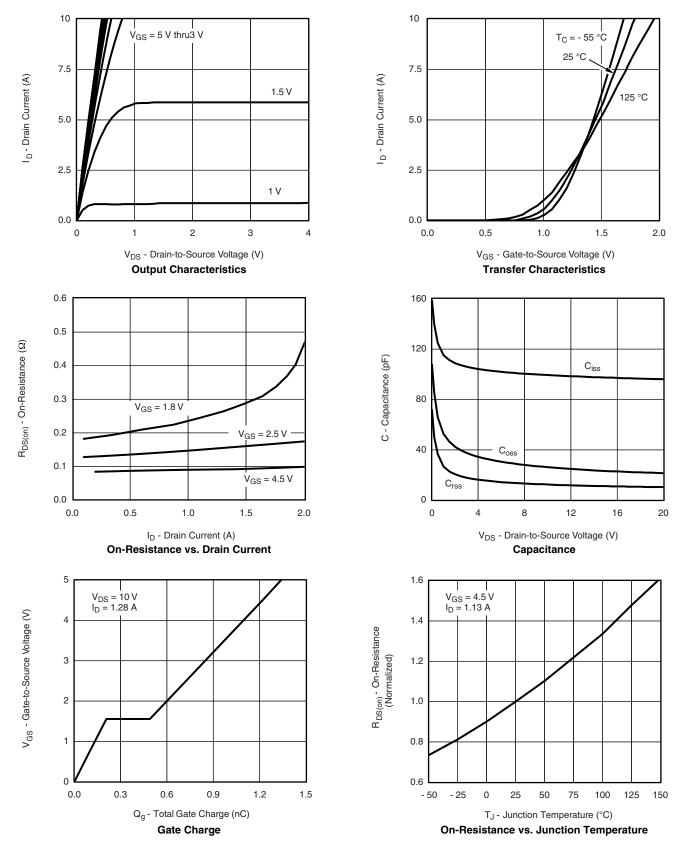
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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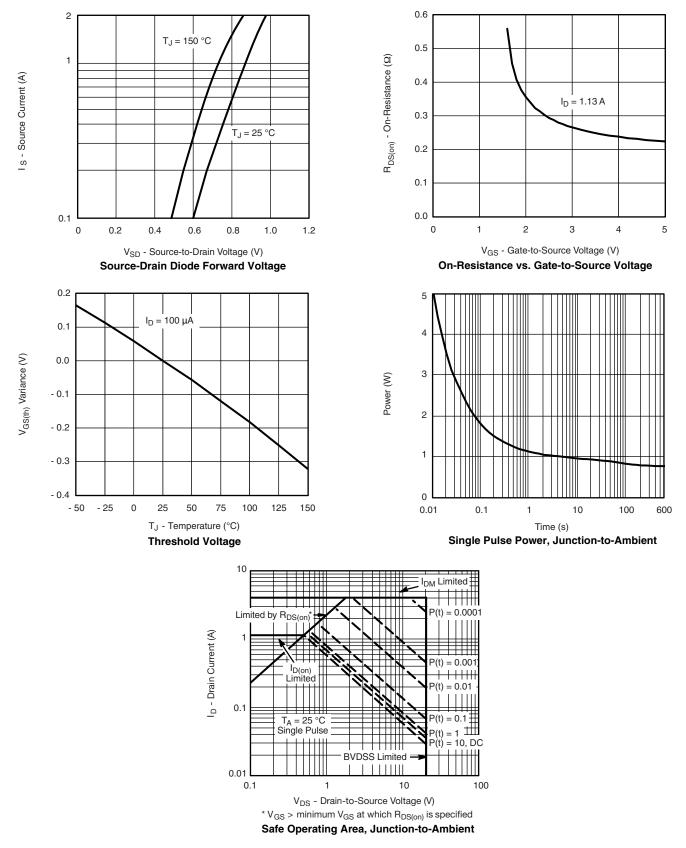


## N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



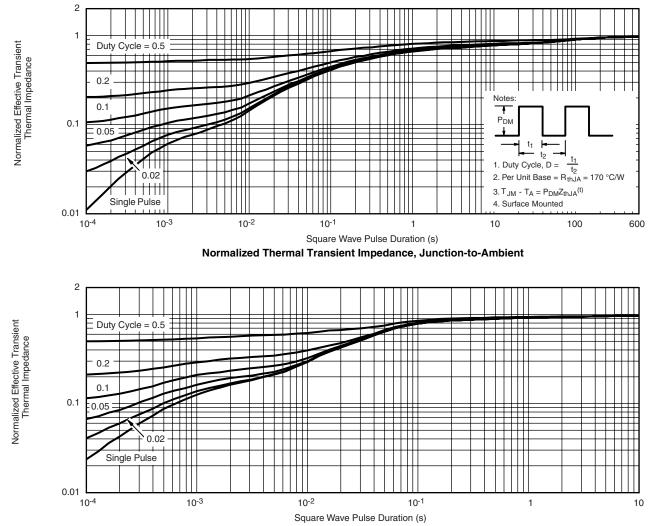


## N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





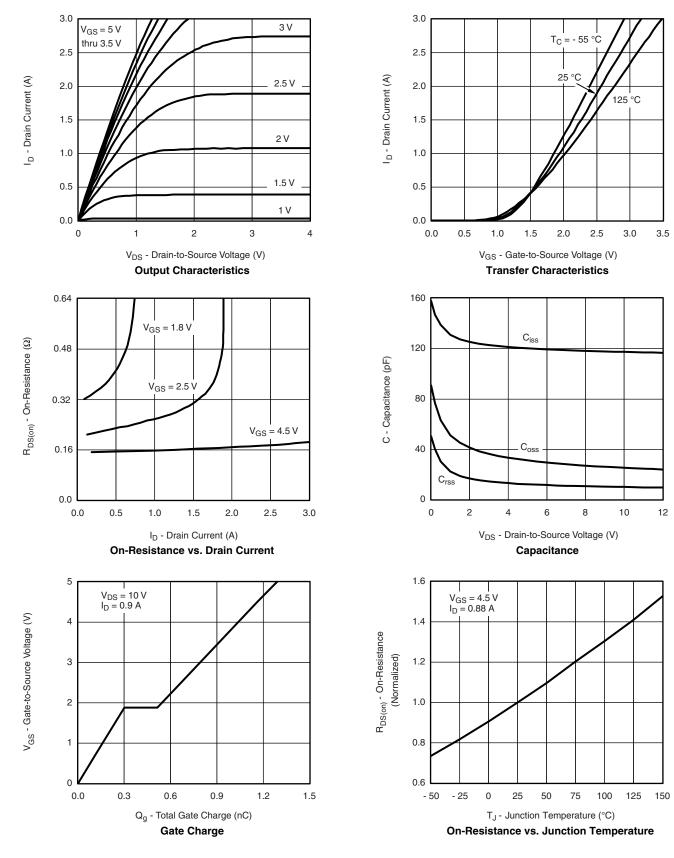
#### N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

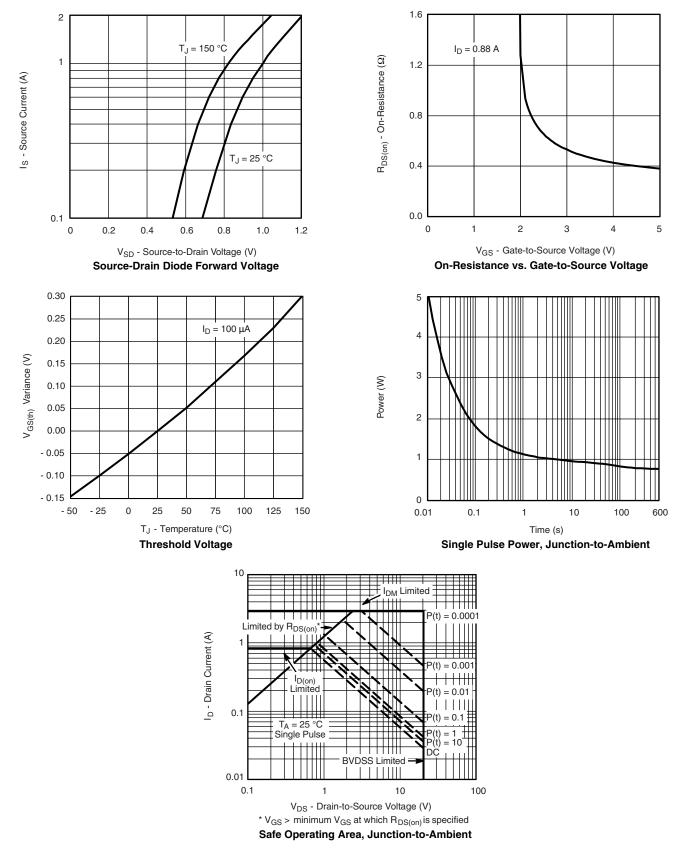


## P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



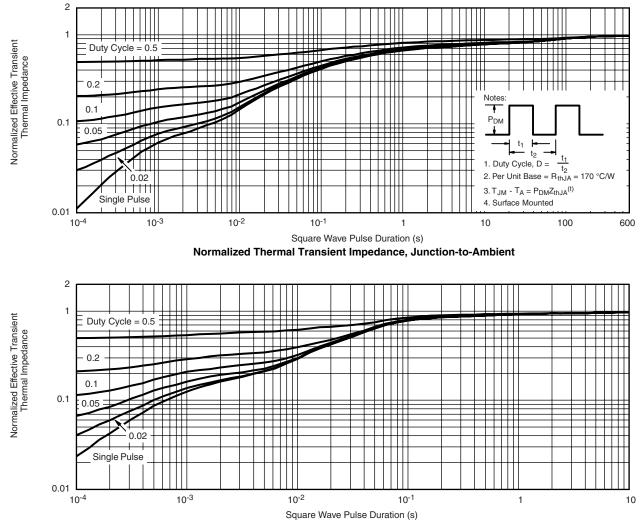


#### P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





## P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot



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